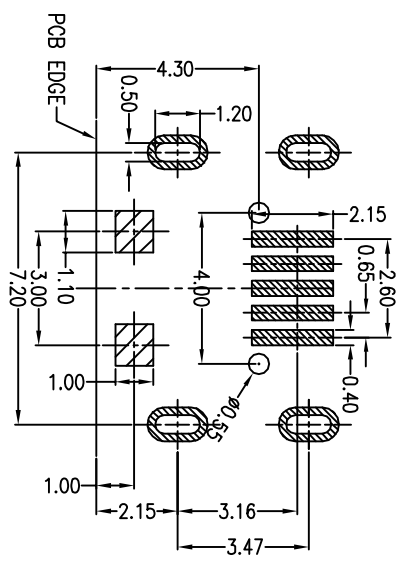
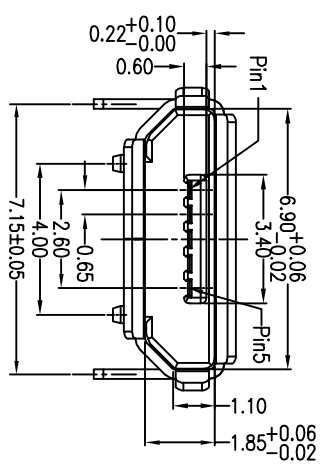
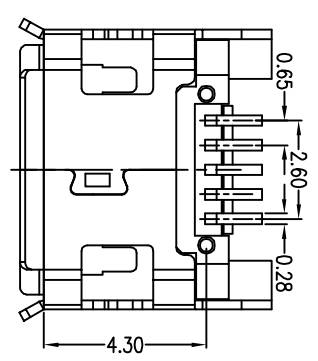
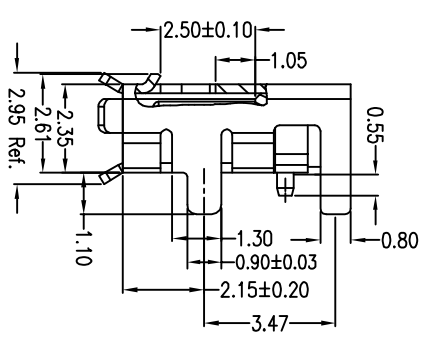
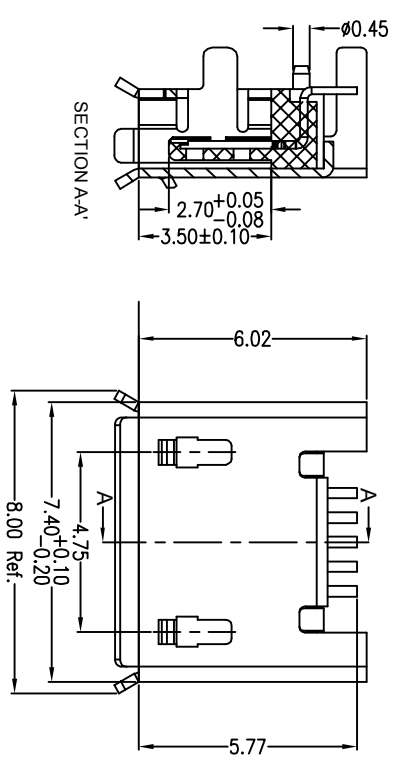
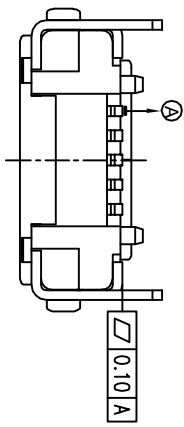


REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE



- Note:
- Material:
 - Housing: High temperature thermoplastic with g.f.U.L94V-0
 - Contact: copper alloy, t=0.20mm
 - Shell: copper alloy, t=0.25mm
- 2.Specification:
- Current rating: 1 A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 50 mW Max.
 - Insulation resistance: 100 MW Min.
 - Total mating force: 3.57 Kgf Max.
 - Total unmating force: 1.0 Kgf Min. 0.81~2.05 Kgf Min.
 - Temperature range: -30°C~80°C

PART	MR-U05703	MATERIA	
MODEL NO:	XX	FINSH:	
UNIT:	MM	SIZE:	A4
TOLERANCE UNSPECIFIED		DR:	
.x	0.25	CHK:	
.xx	0.20	APP:	
.xxx	0.15		
Ang.	2°		
TITLE:		Micro usb 5P/F B Type dip 有导柱有柱7.2 加焊盘加长0.75脚长1.14脚全插	
DWG NO:		MRK-MU11-720-0024	
SCALE:	5:1	DATE:	2013.04.16
REV:		A	

深圳市迈瑞康电子有限公司

